

A

B

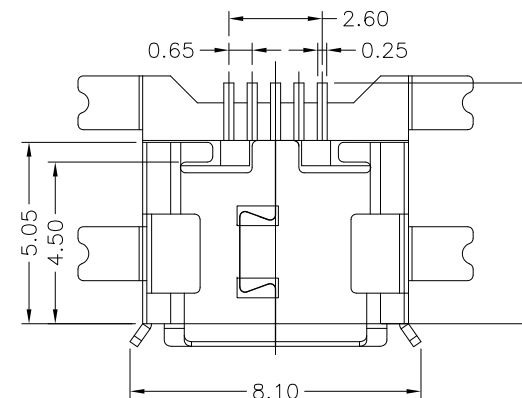
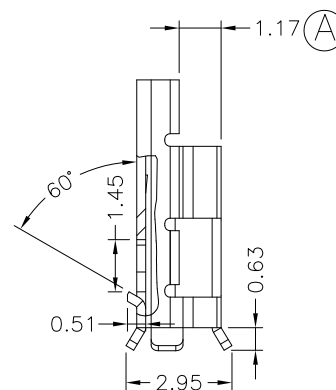
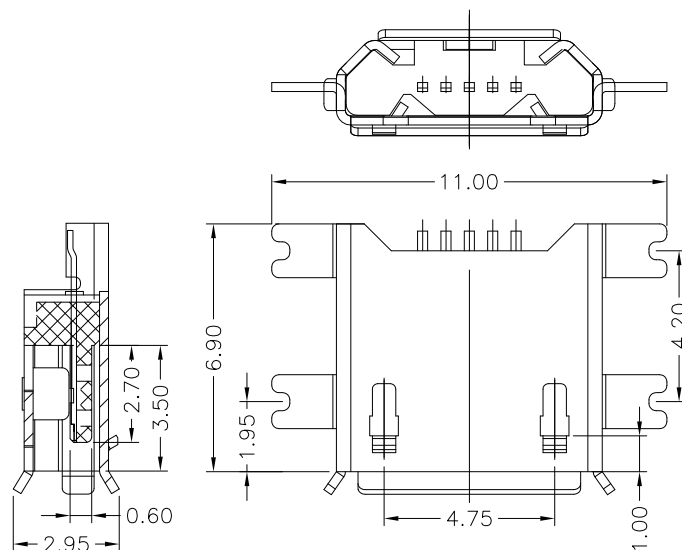
C

D

E

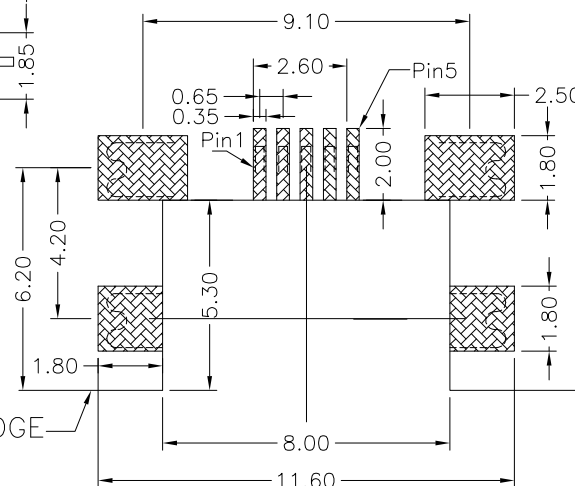
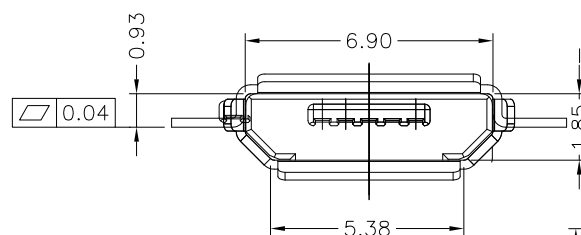
1

1



2

2



MATERIALS

HOUSING: LCP (UL 94V-0),BLACK
SHELL: COPPER ALLOY, TIN PLATING
TERMINAL: COPPER ALLOY, GOLD PLATED

SPECIFICATION

CURRENT RATING: 1.8 AMP MAX (ONLY PIN 1, 5),
OTHER 1 AMP MAX
DIELECTRIC WITHSTANDING: 100V AC FOR ONE MINUTE
CONTACT RESISTANCE: 30m OHMS MAX
INSULATION RESISTANCE: 100M OHMS MIN AT DC 500V
OPERATION TEMPERATURE: -25°C~+105°C

3

3

RECOMMENDED P.C.B LAYOUT



承洧科技股份有限公司
Chong Wei Technology Corp.

DESCRIPTION(內容):

MICRO USB B TYPE, PCB
MOUNT, SMT, BOARD CUT TYPE,
METAL SHIELD, FEMALE (RoHS)

PART NO:
(料號) UMMBF-051MGCBI1-CF1066

DWG NO(圖號): 22TCH-051-124L

DRAWN(製圖):

mandy

CHECKED(確認):

MANDY

APPROVAL(核准):

JOHNNY

GENERAL TOLERANCE:

(公差)

.X ±0.3
.XX ±0.2
.XXX ±0.1

SCALE(比例):

FREE



REV:

R2

UNIT:

mm

SIZE:

A4

SHEET:

1/1

REV

R0

R1

R2

R3

DESCRIPTION

RELEASE

新增(A)部位尺寸

更換確認章

DATE

2014.07.09

2014.10.24

2019.09.17

A

B

C

D

E

CF1066